SP	FC	`IF	IC	ΔΤΙ		NS
ЭΓ	$-\iota$	<i>)</i>	$\mathbf{I} \mathbf{U} \mathbf{I}$	~ I I	v	IVO

CUSTOMER . PTC

SAMPLE CODE · NSC2002WRP-BWA-I

MASS PRODUCTION CODE . NPC2002WRP-BWA-I

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 002

DRAWING NO. (Ver.) JLMD-NPC2002WRP-BWA-I_001

PACKAGING NO. (Ver.) : JPKG-NPC2002WRP-BWA-I_001

Customer Approved

Date:

POWERTIP 2016.02.02

Approved	Checked	Designer
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Preliminary specification for design input

Specification for sample approval

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Total: 30 Pages



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
- 2.4 Display Command
- 2.5 Character Pattern

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix A : LCM drawing Packaging

Note: For detailed information please refer to IC data sheet: SITRONIX---ST7066U-0A



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	20*2 Characters
LCD Type	PBT , Negative , Transmissive
Driver Condition	LCD Module: 1/16 Duty , 1/5 Bias
Viewing Direction	6 O'clock
Weight	52.7g
Interface	6800-series 8-bit parallel
Driver IC	ST7066U
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web site:
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

- 1/1001101110011 × P 001110001011					
Item	Standard Value	Unit			
Outline Dimension	116.0 (L) * 37.0 (W) *13.3 (H)	mm			
Viewing Area	85.0 (L) * 18.5 (W)	mm			
Active Area	73.5 (L) * 11.5 (W)	mm			
Character Size	3.2(L) * 5.55(W)	mm			
Character Pitch	3.7(L) * 5.95(W)	mm			

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

- 1 10 0 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1						
Item	Symbol	Condition	Min.	Max.	Unit	
Power Supply Voltage	V_{DD}	-	-0.3	7.0	V	
LCD Driver Supply Voltage	VLCD	-	VDD -10.0	VDD +0.3	٧	
Input Voltage	Vin	-	-0.3	V _{DD} +0.3	٧	
Operating Temperature	Тор	-	-20	70	$^{\circ}\mathbb{C}$	
Storage Temperature	Tst	-	-30	80	$^{\circ}\mathbb{C}$	
Storage Humidity	H _D	Ta<60 °C	-	90	%RH	

1.4 DC Electrical Characteristics

Ta = 25°℃

			1u - 1			
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V_{DD}	-	4.5	5.0	5.5	V
"H" Input Voltage	ViH	-	0.7 VDD	-	VDD	V
"L" Input Voltage	VIL		-0.3	-	0.6	V
"H" Output Voltage	Vон	IOH=-0.1mA	3.9	-	VDD	V
"L" Output Voltage	Vol	IOL=0.1mA	-	-	0.4	V
Supply Current	I _{DD}	V _{DD} = 5.0 V ,V _O = 0.8 V	-	10	15	mA
		-20°C (VDD= 5.0 V)	-	0.8	-	
LCM Driver Voltage	Vo	25°C (VDD= 5.0 V)	-	0.8	-	V
		70°C (VDD= 5.0 V)	-	0.8	-	



1.5 Optical Characteristics

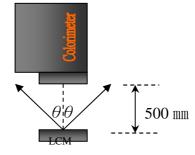
LCD Panel: 1/16 Duty, 1/5 Bias, $V_{LCD} = 8.3$ V, $Ta = 25^{\circ}C$

						T	1	ı
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr	_	-	53	80	ms	Note 2
ixesponse fille	Fall	tf	-	-	33	50	1115	NOIE Z
	Тор	θ+		-	60			
Viewing angle	Bottom	θ-	C ₂ 2 0	-	60	-	Dog	Note 1
range	Left	θL	C <u>></u> 2.0	-	60	-	Deg.	
	Right	θR		-	60	-		
Contrast Ra	tio	С	-	-	124	-	-	Note 3
Average Bright (with LCD)		IV		40	65	-	cd/m ²	
Color of CIE Coordinate		X	IF= 60 mA	0.20	0.25	0.30		Note 4
(With LCD)	Υ		0.24	0.29	0.34	_	11010 1
Uniformity	′	△B		70	-	-	%	

Note 4:

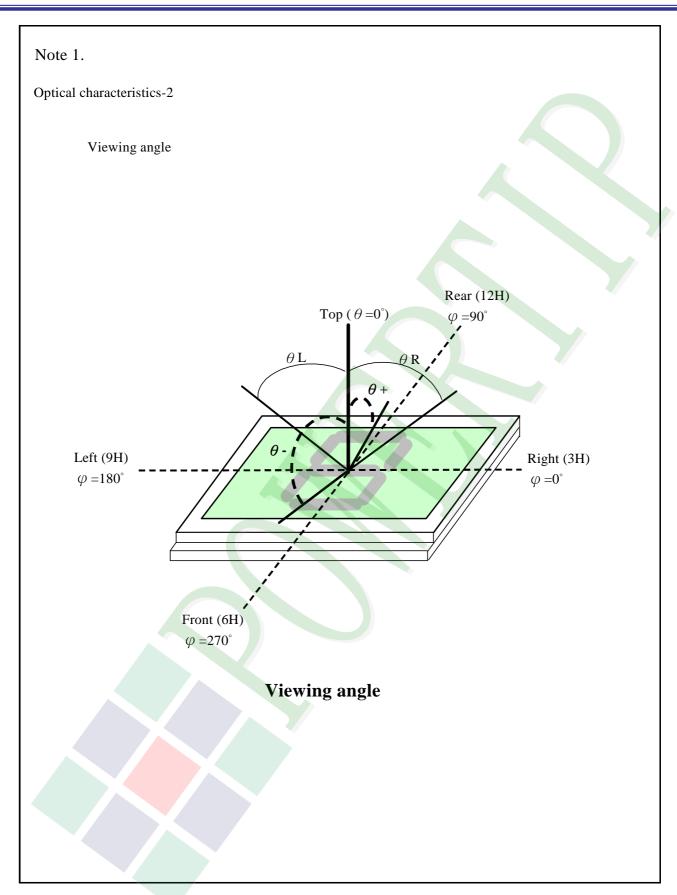
- $1 : \triangle B = B(min) / B(max) * 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a: Environment: $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ / $60\pm20\%$ R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b: Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm 4\%$



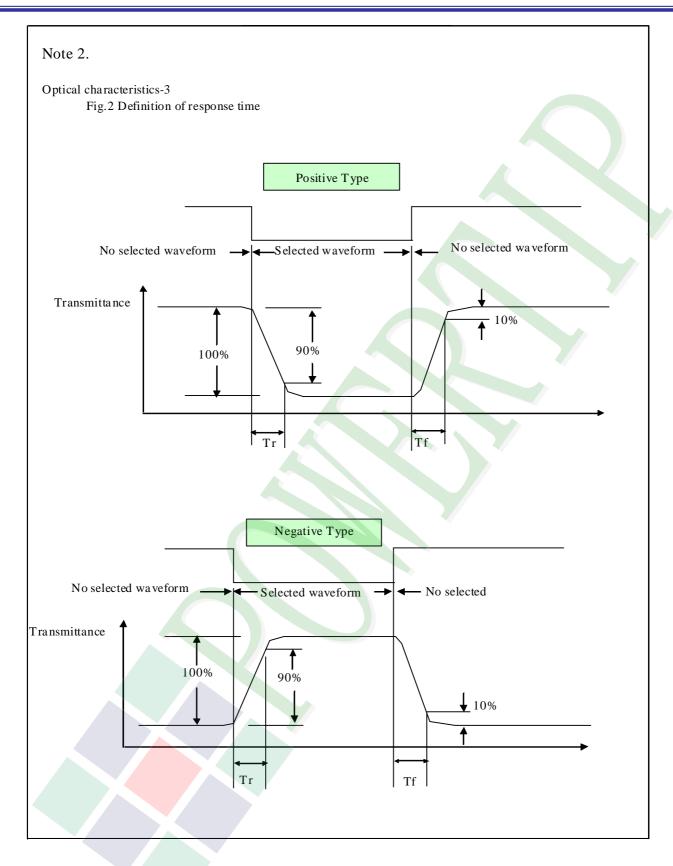


Colorimeter=BM-7 fast











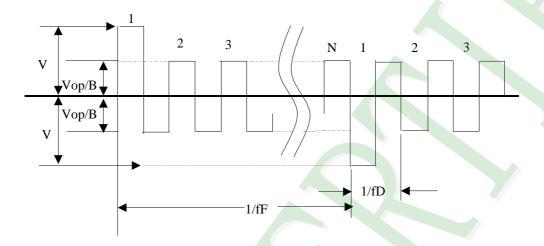
Electrical characteristics-2

※2 Drive waveform

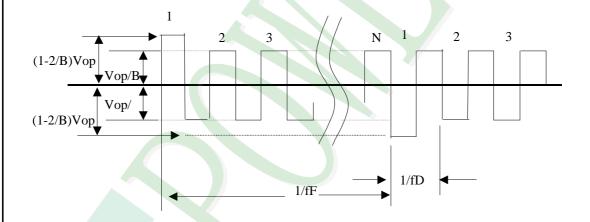
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



(2) Non-Selected wave form



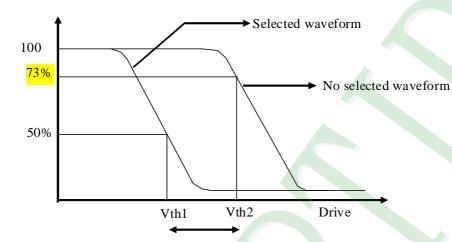
Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period



Note 3.: Definition of Vth

Transmittance



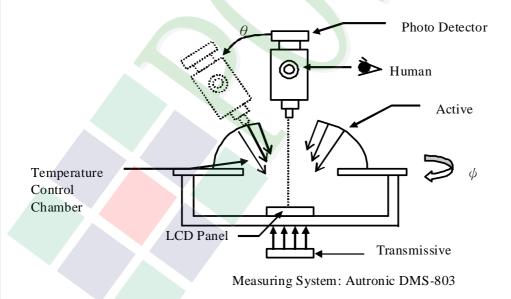
Active voltage range

	Vth1	Vth2
View direction	10°	40°
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





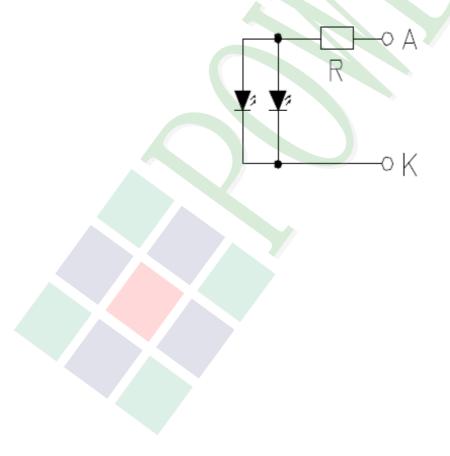
1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°ℂ	-	180	mA
Reverse Voltage	VR	Ta =25°ℂ	-	5	V
Power Dissipation	PD	Ta =25°ℂ	- 🔨	630	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		3.1	3.3	3.5	V
Average Brightness (without LCD)	IV	IF= 60 mA	1400	1700	-	cd/m ²
CIE Color Coordinate	Х		0.255	0.285	0.315	
(Without LCD)	Υ		0.255	0.285	0.315	-
Color			White			





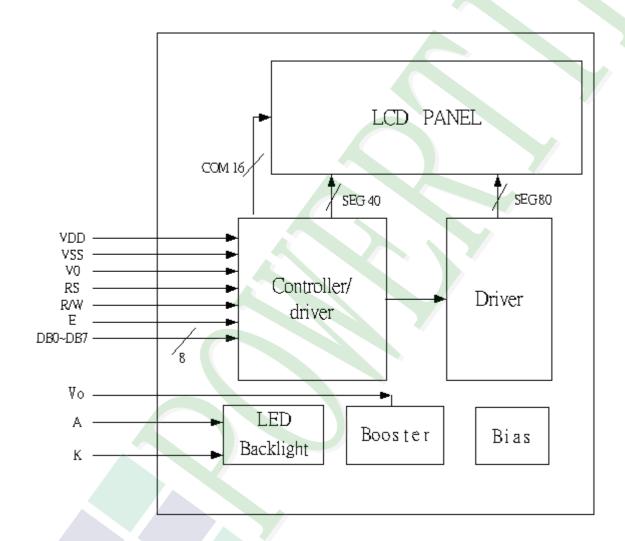
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





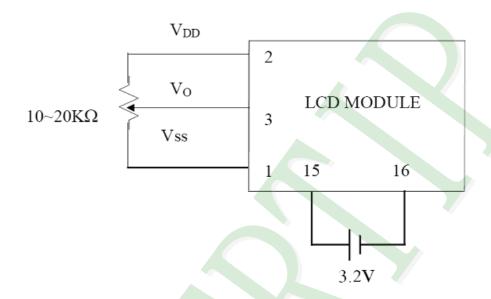
2.2 Interface Pin Description

Pin No.	Symbol	Signal Description			
1	Vss	Power Supply (Vss=0)			
2	V _{DD}	Power Supply (5V)			
3	Vo	Operating voltage for LCD			
		Register Selection input			
4	RS	High = Data register			
	110	Low = Instruction register (for write)			
		Busy flag address counter (for read)			
_	DAM	Read/Write signal input is used to select the read/write mode			
5	R/W	High = Read mode, Low = Write mode			
6	E	Start enable signal to read or write the data			
7	DB0				
8	DB1	Four low order bi-directional three-state data bus lines. Use for data transfer between the MPU and the LCD module.			
9	DB2				
10	DB3	These four are not used during 4-bit operation.			
11	DB4				
12	DB5	Four high order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCD module.			
13	DB6				
14	DB7	DB7 can be used as a busy flag.			
15	Α	LED+			
16	K	LED-			



2.2.1 Application Notes

Contrast Adjust



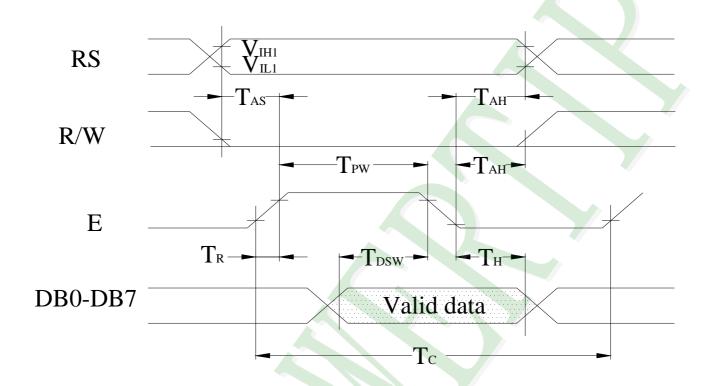
2.2.2 Refer Initial code

```
void initial()
{
    delay(40);
    write_com(0x01);
    delay(5);
    write_com(0x38);
    delay(5);
    write_com(0x0c);
    delay(5);
    write_com(0x06);
    delay(5);
```

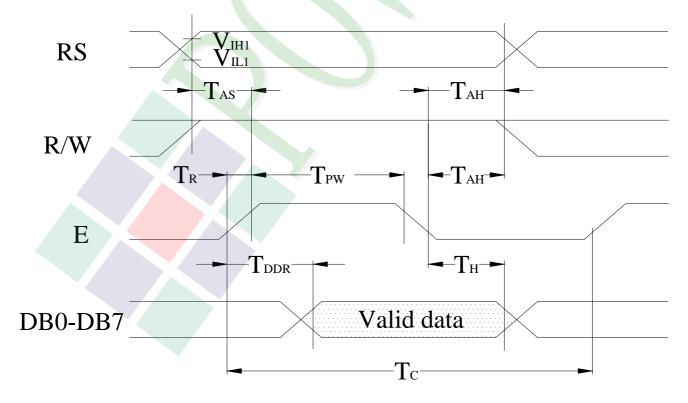


2.3 Timing Characteristics

Writing data from MPU to ST7066U



Reading data from ST7066U to MPU





Write Mode (Writing data from MPU to ST7066U)

 $(VDD = 5V,Ta=25^{\circ}C)$

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Tc	Enable Cycle Time	Pin E	1200	-		ns
T _{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T _R , T _F	Enable Rise / Fall Time	Pin E	-	- (25	ns
Tas	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
Тан	Address Hold Time	Pins :RS,RW,E	10	<u></u>	-	ns
Tosw	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
Тн	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

Read Mode (Reading data from ST7066U to MPU)

 $(VDD = 5V,Ta=25^{\circ}C)$

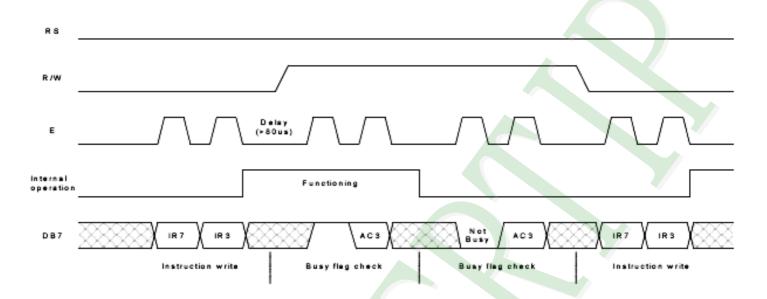
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Tc	Enable Cycle Time	Pin E	1200	1	ı	ns
T _{PW}	Enable Pulse Width	Pin E	140	-	ı	ns
T _R , T _F	Enable Rise / Fall Time	Pin E	-	-	25	ns
Tas	Address Setup Time	Pins: RS , RW,E	0	-	ı	ns
T _{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T_DDR	Data Setup Time	Pins:DB0~DB7	1	ı	100	ns
Тн	Data Hold Time	Pins:DB0~DB7	10	ı		ns





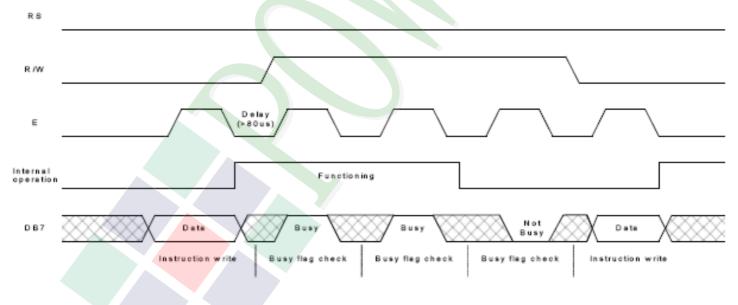
For 4-bit interface date, only four bus lines (DB4 to DB7) are used for transfer.

Example of busy flag check timing sequence



For 8-bit interface date, all eight bus lines (DB0 to DB7) are used .

Example of busy flag check timing sequence





2.4 Display Command

				I	nstru	ction	Code	Э				Description
Instructions	RS	R/ W	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	Description	Time (270KHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC.	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	×	Set DDRAM address to "00H" from AC and return cursor to it's original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37μs
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	D=1 : entire display on C=1 : cursor on B=1 : cursor position on	37 μs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	×	×	Set cursor moving and display shift control bit, and the the direction, without changing of DDRAM data.	37µs
Function Set	0	0	0	0	1	DL	N	F	×	×	DL: interface data is 8/4 bits NL: number of line is 2/1 F: font size is 5×11/5×8	37µs
Set CGRAM Address	0	0	0	1	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set CGRAM address in address counter.	37μs
Set DDRAM Address	0	0	1	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set DDRAM address in address counter.	37 μs
Read Busy Flag and Address	0	1	B F	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0μs



Write Data to RAM	1	0	D 7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	37µs
Read Data from RAM	1	1	D 7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	37µs

Note:

Be sure the ST7066U is not in the busy state (BF=0) before sending an instruction from the MPU to the ST7066.

If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself.

Before checking BF, be sure to wait at least 80us.. Do not keep "E" always "High" for checking BF Refer to Instruction Table for the list of each instruction execution time.



2.5 Character Pattern

NO.7066-0A

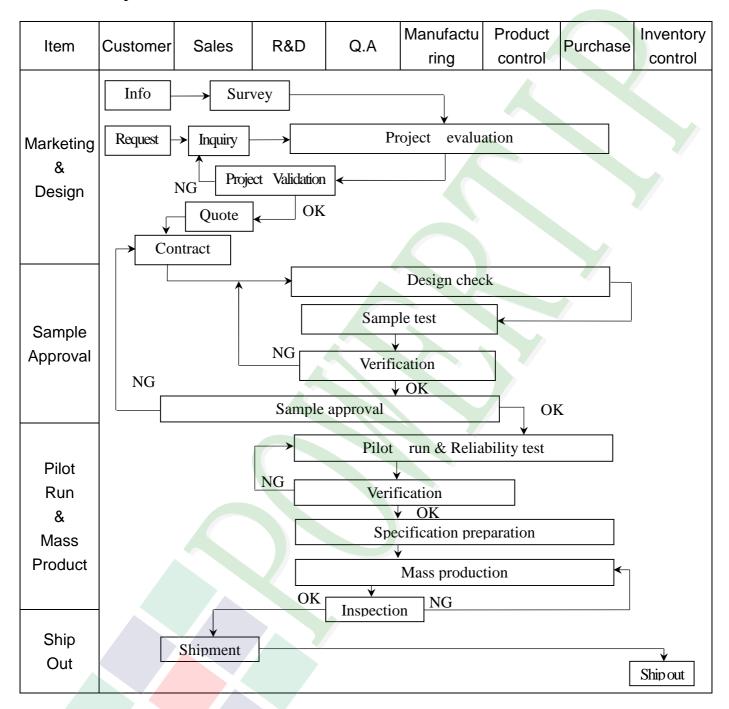
b7- b4	0000 0000		0010	0011	0100	0101	0.110	0111	1000	1001	1010	1011	1100	1101	1110	1111
P3-P0		111111	1111111	DESERV	DIDD		HAME		1000	1001	1010	HU11		Balana.	HHH	
0000	CG RAM (1)															
0001	(2)															
0010	3															
0011	(4)															
0100	(5)															
0101	(6)															
0110	7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
11 00	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

2.6 JUMPER (Setting different use) J1,J3,J5,JM,JF

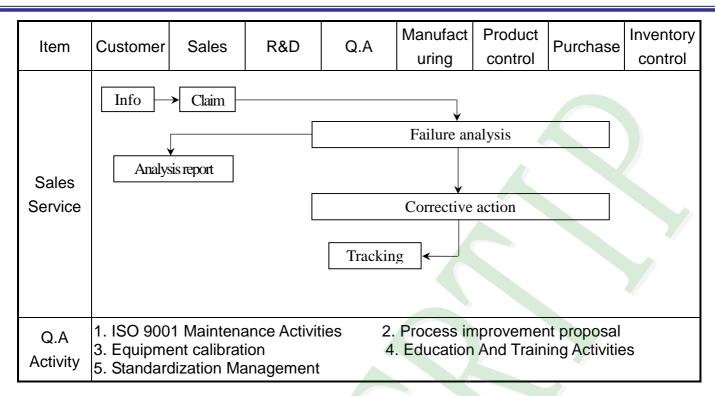


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- **♦**OUT Going Defect Level : Sampling .
- ◆Manner of appearance test :
 - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). Standard of inspection: (Unit: mm)
 - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (4). Definition of area . (Fig. 2)

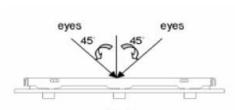


Fig.1

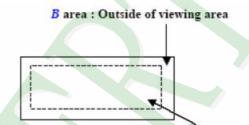


Fig. 2 A area: viewing area

♦ Specification:

NO	Item	Criterion	Level			
	Product condition	1. 1 The part number is inconsistent with work order of Production.	Major			
01		1. 2 Mixed production types.	Major			
		1. 3 Assembled in inverse direction.	Major			
02	Quantity	2. 1 The quantity is inconsistent with work order of production.				
03	Outline dimension	3. 1 Product dimension and structure must conform to Structure diagram.				
		4. 1 Missing line character and icon.	Major			
		4. 2 No function or no display.	Major			
04	Electrical Tes <mark>ting</mark>	4, 3 Output data is error.	Major			
		4, 4 LCD viewing angle defect.	Major			
		4. 5 Current consumption exceeds product specifications.	Major			



◆Specification For Monotype and Color STN:

(Ver. B01)

NO	Item	C	riteri	on			Level	
	Black or white dot \ scratch \ contamination	 5. 1 Round type: 5. 1. 1 display only: • White and black spots on display ≤ 0. 30 mm, no more than 4 white or black spots present. • Densely spaced: NO more than two spots or lines within 3 mm. 						
		5. 1. 2 Non-display:						
	Round type	Dimension	4	Acceptance	(Q't	y)		
	Round type	(diameter : Φ)	A area B area			area		
	→ _X ← ↓	$\Phi \leq 0.10$	Acc	ept no dense				
05	Y	$0.10 < \Phi \leq 0.20$	3		т.	gnovo	Minor	
0.5		$0.20 < \Phi \leq 0.30$		2		gnore	WIHOI	
	$\Phi = (x+y)/2$	Total quantity		4				
		5. 1. 3 Line type:						
	I in a term a	Dimension		Accep	tanc	e (Q'ty)		
	Line type	Length (L) Width (W)		A area		B area		
	✓ / ¥ W	W ≤ (0. 03	Accept no de	nse			
	→ , 	$L \le 3.0$ $0.03 < W \le 0$	0. 05 4 I		Ignore			
	L	$L \le 2.5$ $0.05 < W \le 0.$	075					
		W >0.	. 075 As round type					
		Dimension		Acceptan	ce (Q	'ty)		
		(diameter : Φ)		A area		B area		
		$\Phi \leq 0.20$	Ac	cept no dense				
06	Polarizer	$0.20 < \Phi \leq 0.50$		3				
30	Bubble	$0.50 < \Phi \le 1.00$	2			Ignore	Minor	
		Φ > 1.00		0				
		Total quantity		4				
		1 0	<u> </u>					



♦Specification For Monotype and Color STN:

(Ver. B01)

NO	Item	Criterion	·	Level
		Z: The thickness of crack W:	The width of crack. terminal length LCD side length	
		7.1 General glass chip: 7.1.1 Chip on panel surface and crack	between panels:	
		Z Z	Z X Y	
07	The crack of glass	SP Y	SP (NG)	Minor
		Seal width	Y	
		X Y	Z	
		≤ a Crack can't enter viewing area	≦1/2 t	
		≤ a Crack can't exceed the half of SP width.	1/2 t < Z ≤2 t	



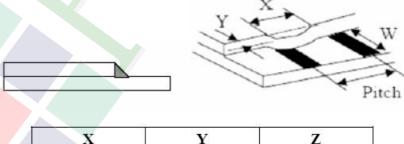
♦Spec	ification For Mo	otype and Color STN:							
NO	Item	Criterion	Level						
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 7. 1. 2 Corner crack:							
		X Y Z							
		≤1/5 a Crack can't enter viewing area Z ≤ 1/2 t							
	The crack of	$\leq 1/5$ a Crack can't exceed the half of SP width. 1/2 t < Z ≤ 2 t							
07	glass		Minor						
	-	7.2 Protrusion over terminal:							
		7. 2. 1 Chip on electrode pad:							
		X							
		X Y Z							
		Front \leq a \leq 1/2 W \leq t							
		Back Neglect							



◆Specification For Monotype and Color STN: (Ver. B01) NO Item Criterion Level Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 7. 2. 2 Non-conductive portion: $\dot{\mathbf{X}}$ Z The crack of 07 Minor glass ≤1/3 a \leq W ≦t

> ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.





1	L
≤ 1/3 W	≦ t
	≤ 1/3 W



◆Specification For Monotype and Color STN:

(Ver. B01)

NO	Item	Criterion	Level
	Backlight elements	8. 1 Backlight can't work normally.	Major
08		8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
		9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CO	ONDITION				
1	High Temperature Storage Test	Keep in 80 ±2℃ 96 hrs Surrounding temperature, then 4hrs.	storage at normal condition				
2	Low Temperature Storage Test	Keep in -30 ±2°C 96 hrs Surrounding temperature, then 4hrs.	storage at normal condition				
3	High Temperature / High Humidity Storage Test	Keep in +60 $^{\circ}$ / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)					
4	Temperature Cycling Storage Test	-30°C→ +25°C → 80°C → +25°C (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.					
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance : 15°C ~35°C 2. Humidity relative : 30%~60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least					
6	Vibration Test (Packaged)	 (Tolerance if the output voltage indication: ±5%) Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration: 1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 					
7	Drop T <mark>est</mark> (Packaged)	Packing Weight (Kg 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454 Drop Direction : %1 corner / 3 e	122 76 61 46				



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ±5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

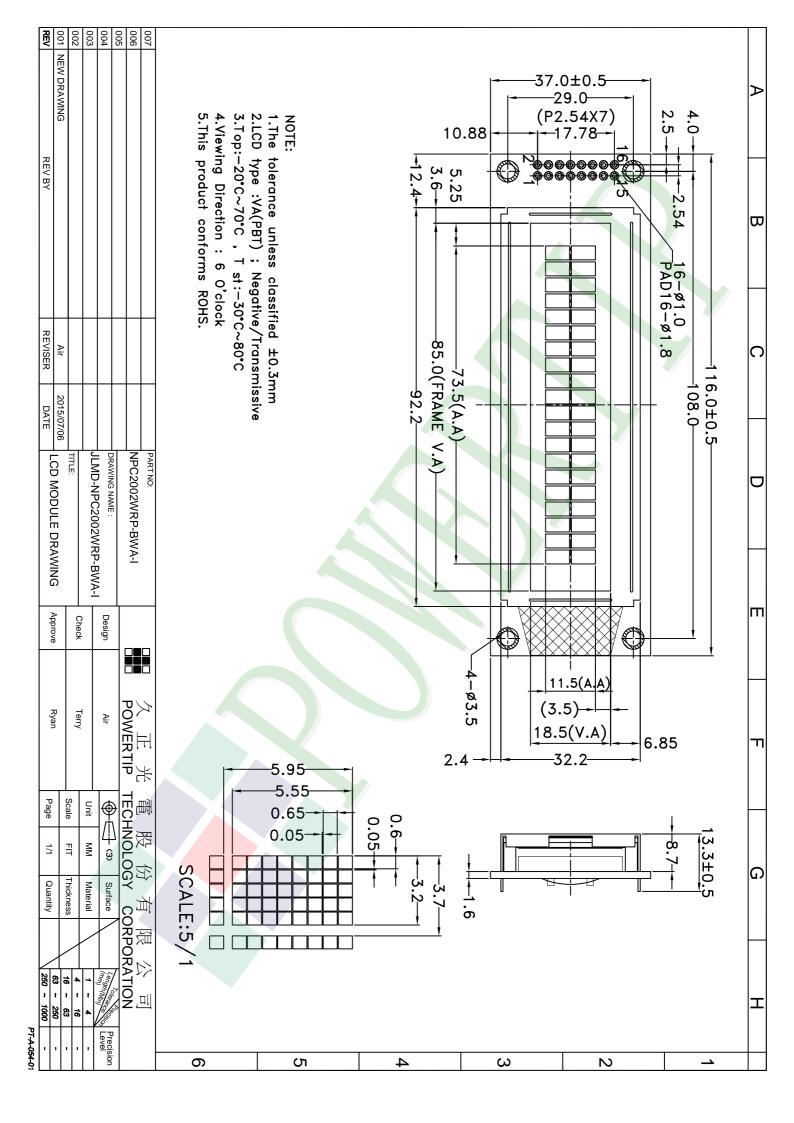
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver.001

Documents NO. JPKG-NPC2002WRP-BWA-I

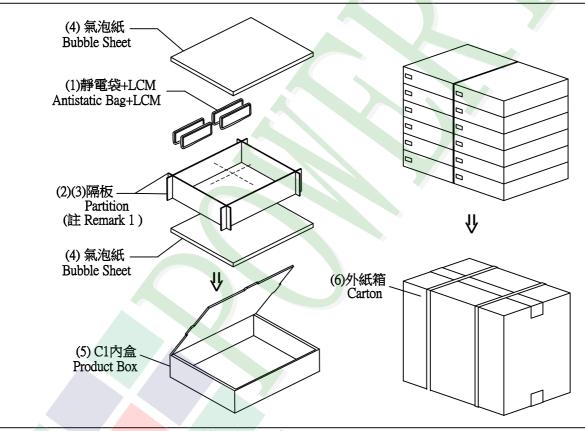
LCM包裝規格書 LCM Packaging Specifications

Approve	Check	Contact	
Ryan	Тетту	Air	

1.包裝材料規格表 (Packaging Material): (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	NPC2002WRP-BWA-I	116.0 X 37.0 X 13.3	0.0527	312	16.4424
2	靜電袋(1)Antistatic Bag	BAG150120ARABA	150 X 120	0.0018	312	0.5616
3	A1-1隔板(2)A1-1 Partition	BX29500047BZBA	295 X 47 X 3	0.0078	168	1.3104
4	B1-1隔板(3)B1-1 Partition	BX24500047BZBA	245 X 47 X 3	0.0065	36	0.234
5	氣泡紙(4)Bubble Sheet	BAG280240BWABA	280 X 240	0.006	24	0.144
6	C1内盒(5)Product Box	BX31025555AABA	310 X 255 X 55	0.13	12	1.56
7	外紙箱(6)Carton	BX52732536CCBA	527 X 325 X 360	0.83	1	0.83
8						
9						

- 2.— 整箱總重量 (Total LCD Weight in carton): 21.08 Kg±10%
- 3.單箱數量規格表 (Packaging Specifications and Quantity):
 - (1)Quantity Of Spacer: A1-1隔板 X 14 , B1-1隔板 X 3
- (2) Total LCM quantity in carton: quantity per box 26 x no of boxes 12 = 312



特記事項(REMARK)

- 1. LCM排放示意圖(前後間隔不放置):
- 1. LCM placed as figure showing:

 (First and last slot should be empty)

